

### **NCE N-Channel Super Trench II Power MOSFET**

#### **Description**

The series of devices uses **Super Trench II** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of  $R_{\text{DS(ON)}}$  and  $Q_g$ . This device is ideal for high-frequency switching and synchronous rectification.

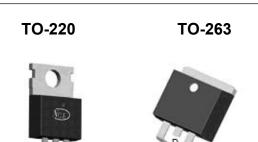
#### **Application**

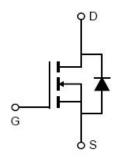
- DC/DC Converter
- •Ideal for high-frequency switching and synchronous rectification

#### **General Features**

- $V_{DS}$  =85V, $I_D$  =160A  $R_{DS(ON)}$ =3.10m $\Omega$  , typical (TO-220)@  $V_{GS}$ =10V  $R_{DS(ON)}$ =2.95m $\Omega$  , typical (TO-263)@  $V_{GS}$ =10V
- Excellent gate charge x R<sub>DS(on)</sub> product(FOM)
- Very low on-resistance R<sub>DS(on)</sub>
- 175 °C operating temperature
- Pb-free lead plating

100% UIS TESTED! 100% ΔVds TESTED!





Schematic Diagram

#### **Package Marking and Ordering Information**

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCEP033N85	NCEP033N85	TO-220	-	-	-
NCEP033N85D	NCEP033N85D	TO-263	-	-	-

#### Absolute Maximum Ratings (T<sub>c</sub>=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V <sub>DS</sub>	85	V
Gate-Source Voltage	V <sub>G</sub> s	±20	V
Drain Current-Continuous	I <sub>D</sub>	160	Α
Drain Current-Continuous(T <sub>C</sub> =100 ℃)	I <sub>D</sub> (100℃)	120	Α
Pulsed Drain Current	I <sub>DM</sub>	640	Α
Maximum Power Dissipation	P <sub>D</sub>	220	W
Derating factor		1.47	W/℃
Single pulse avalanche energy (Note 1)	E <sub>AS</sub>	1295	mJ
Operating Junction and Storage Temperature Range	$T_{J}, T_{STG}$	-55 To 175	$^{\circ}$



# NCEP033N85, NCEP033N85D

#### **Thermal Characteristic**

Thermal Resistance, Junction-to-Case	$R_{ heta JC}$	0.68	°C/W	
,-	***		1	1

#### Electrical Characteristics (T<sub>C</sub>=25°C unless otherwise noted)

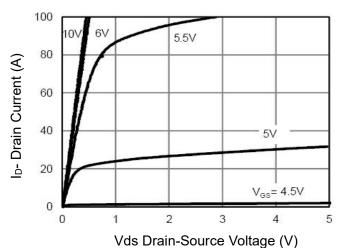
Parameter	Symbol	Condition		Min	Тур	Max	Unit
Off Characteristics				•	•		
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250μA		85		-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =85V,V <sub>GS</sub> =0V		-	-	1	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	$V_{GS}=\pm20V, V_{D}$	os=0V	-	-	±100	nA
On Characteristics							
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS}=V_{GS},I_{D}=2$	50μA	2.0	3.0	4.0	V
D : 0	-	)/ 40\/ L 00A	TO-220	-	3.1	3.3	mΩ
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =80A TO-263	TO-263		2.95	3.3	mΩ
Gate resistance	R <sub>G</sub>			-	1.9	-	Ω
Forward Transconductance	<b>g</b> FS	V <sub>DS</sub> =5V,I <sub>D</sub> =8	80A		90	-	S
Dynamic Characteristics	1						
Input Capacitance	Clss	V <sub>DS</sub> =40V,V <sub>GS</sub> =0V, F=1.0MHz		-	7200	-	PF
Output Capacitance	Coss			-	1100	-	PF
Reverse Transfer Capacitance	Crss			-	24	-	PF
Switching Characteristics (Note 2)	,			•			
Turn-on Delay Time	t <sub>d(on)</sub>			-	21	-	nS
Turn-on Rise Time	tr	$V_{DD}$ =40V, $I_{D}$ =80A $V_{GS}$ =10V, $R_{G}$ =1.6 $\Omega$		-	12.5	-	nS
Turn-Off Delay Time	t <sub>d(off)</sub>			-	48	-	nS
Turn-Off Fall Time	t <sub>f</sub>			-	12	-	nS
Total Gate Charge	Qg	V <sub>DS</sub> =40V,I <sub>D</sub> =80A, V <sub>GS</sub> =10V		-	115	-	nC
Gate-Source Charge	Q <sub>gs</sub>			-	39		nC
Gate-Drain Charge	Q <sub>gd</sub>			-	32		nC
Drain-Source Diode Characteristics	1			1			
Diode Forward Voltage	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =8	80A	-		1.2	V
Diode Forward Current	Is			-	-	160	Α
Reverse Recovery Time	t <sub>rr</sub>	T <sub>J</sub> = 25°C, I <sub>F</sub> :	= 80A	-	80	-	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs		-	147	-	nC

#### Notes:

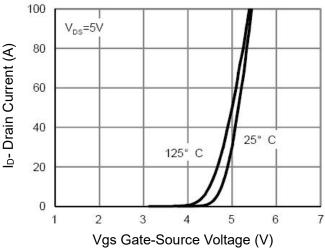
- 1. EAS condition : Tj=25  $^{\circ}\text{C}$  ,VDD=40V,VG=10V,L=0.5mH,Rg=25 $\Omega$
- 2. Guaranteed by design, not subject to production
- 3. These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsin k, assuming a maximum junction temperature of TJ(MAX)=175° C. The SOA curve provides a single pulse rating.



#### **Typical Electrical and Thermal Characteristics**



**Figure 1 Output Characteristics** 



**Figure 2 Transfer Characteristics** 

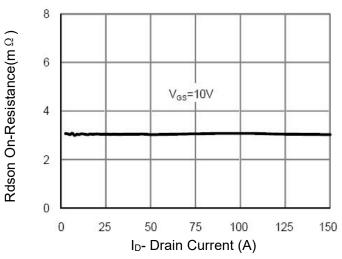


Figure 3 Rdson- Drain Current

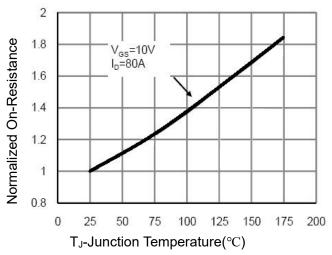


Figure 4 Rdson-Junction Temperature

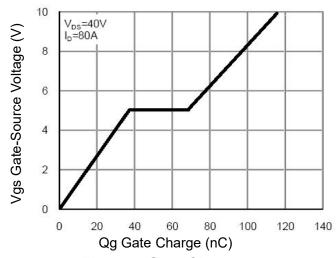


Figure 5 Gate Charge

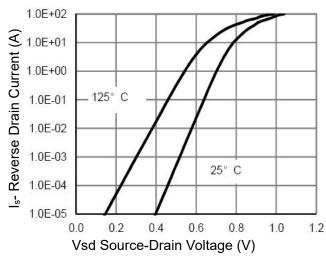


Figure 6 Source- Drain Diode Forward



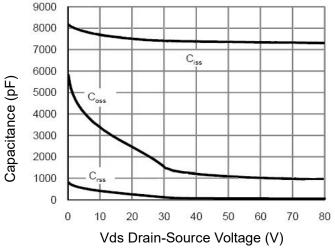


Figure 7 Capacitance vs Vds

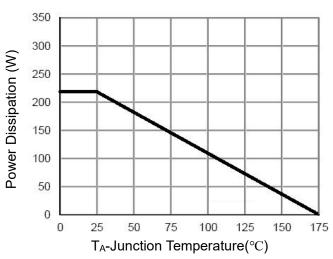


Figure 9 Power De-rating

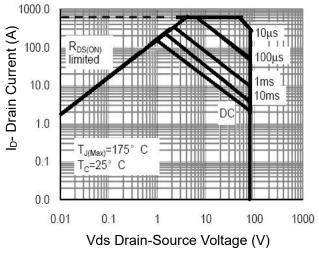


Figure 8 Safe Operation Area (Note 3)

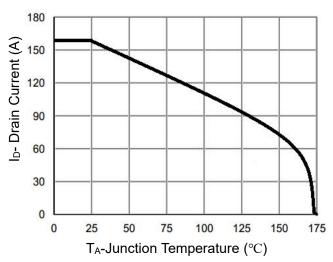
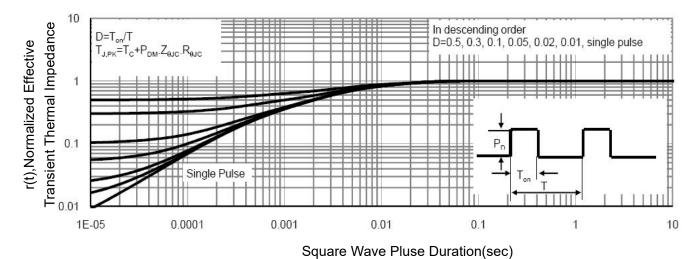


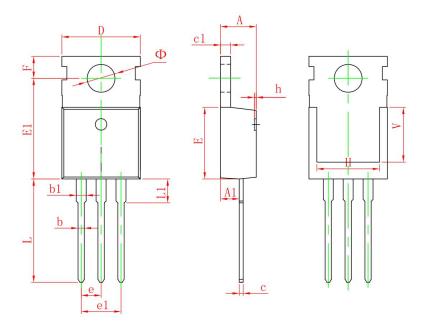
Figure 10 Current De-rating



**Figure 11 Normalized Maximum Transient Thermal Impedance** 



## **TO-220-3L Package Information**

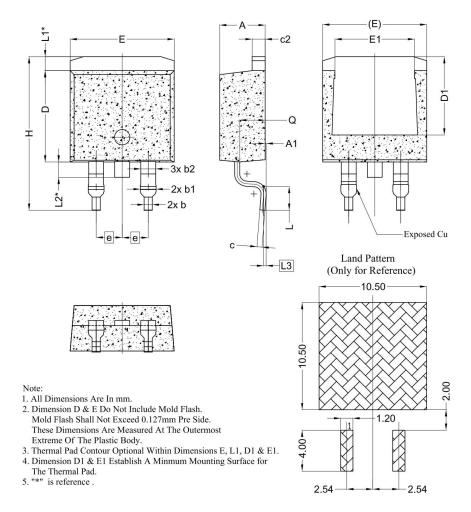


Cumbal	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
Α	4.400	4.600	0.173	0.181	
A1	2.250	2.550	0.089	0.100	
b	0.710	0.910	0.028	0.036	
b1	1.170	1.370	0.046	0.054	
С	0.330	0.650	0.013	0.026	
c1	1.200	1.400	0.047	0.055	
D	9.910	10.250	0.390	0.404	
E	8.950	9.750	0.352	0.384	
E1	12.650	13.050	0.498	0.514	
е	2.540	TYP.	0.100	TYP.	
e1	4.980	5.180	0.196	0.204	
F	2.650	2.950	0.104	0.116	
Н	7.900	8.100	0.311	0.319	
h	0.000	0.300	0.000	0.012	
L	12.900	13.400	0.508	0.528	
L1	2.850	3.250	0.112	0.128	
V	6.900 REF.		0.276	REF.	
Ф	3.400	3.800	0.134	0.150	

http://www.ncepower.com



### **TO-263-2L Package Information**



SYMBOL	DIMENSIONS			
STIVIBUL	MIN.	NOM.	MAX.	
Α	4.24 4.44		4.64	
A1	0.00	0.10	0.25	
b	0.70	0.80	0.90	
b1	1.20	1.55	1.75	
b2	1.20	1.45	1.70	
С	0.40	0.50	0.60	
c2	1.15	1.27	1.40	
D	8.82 8.92		9.02	
D1	6.86	7.65	-	
Е	9.96	10.16	10.36	
E1	6.89 7.77		7.89	
е	2.54 BSC			
Н	14.61	15.00	15.88	
L	1.78	2.32	2.79	
L1	1.36 REF.			
L2	1.50 REF.			
L3	0.25 BSC			
Q	2.30	2.70		

V2.0

# NCEP033N85, NCEP033N85D



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